

IMPROVE TRACTION INVERTER SYSTEM EFFICIENCY AT LOWER COST

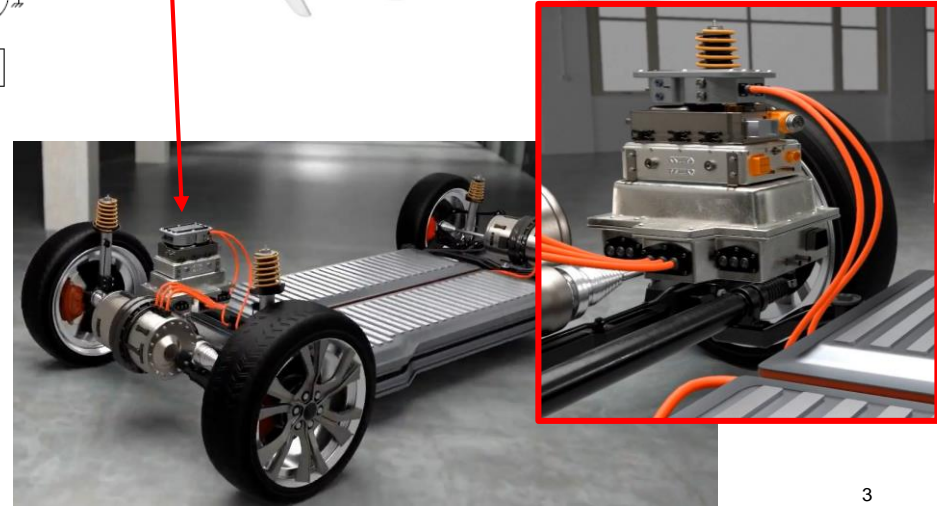
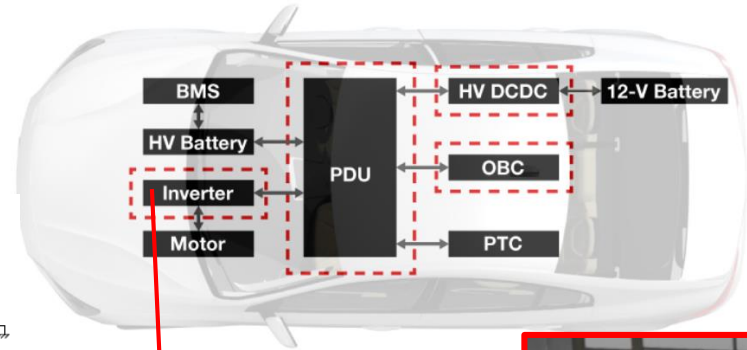
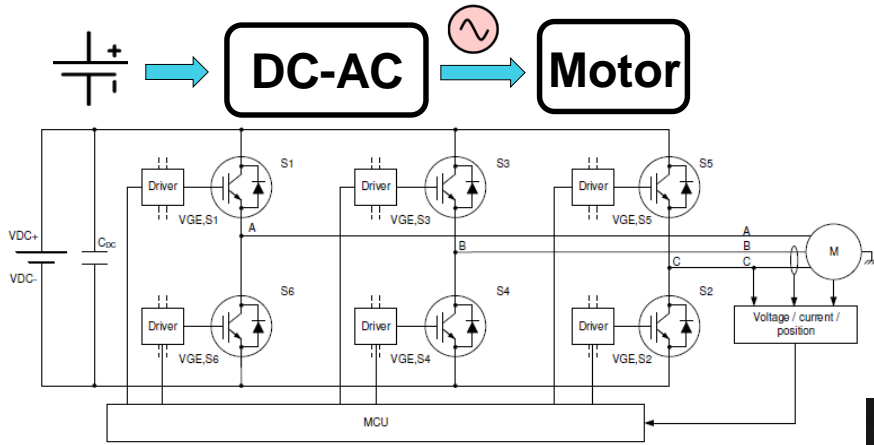
New Product
Update

George Lakkas
— Product Marketing Engineer
High Power Drivers

Agenda

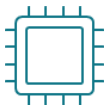
- Key traction inverter design considerations
- Isolated gate drivers for EV/HEV traction inverters
- Real-time variable gate drive
 - Traction inverter operating conditions that impact the power switch
 - UCC5880-Q1 value proposition
 - Real-time variable gate drive strength concept and design
 - Experimental test data showing impact of variable drive strength
 - EV benefits
- Design support tools

Introduction of traction inverters in EV/HEV



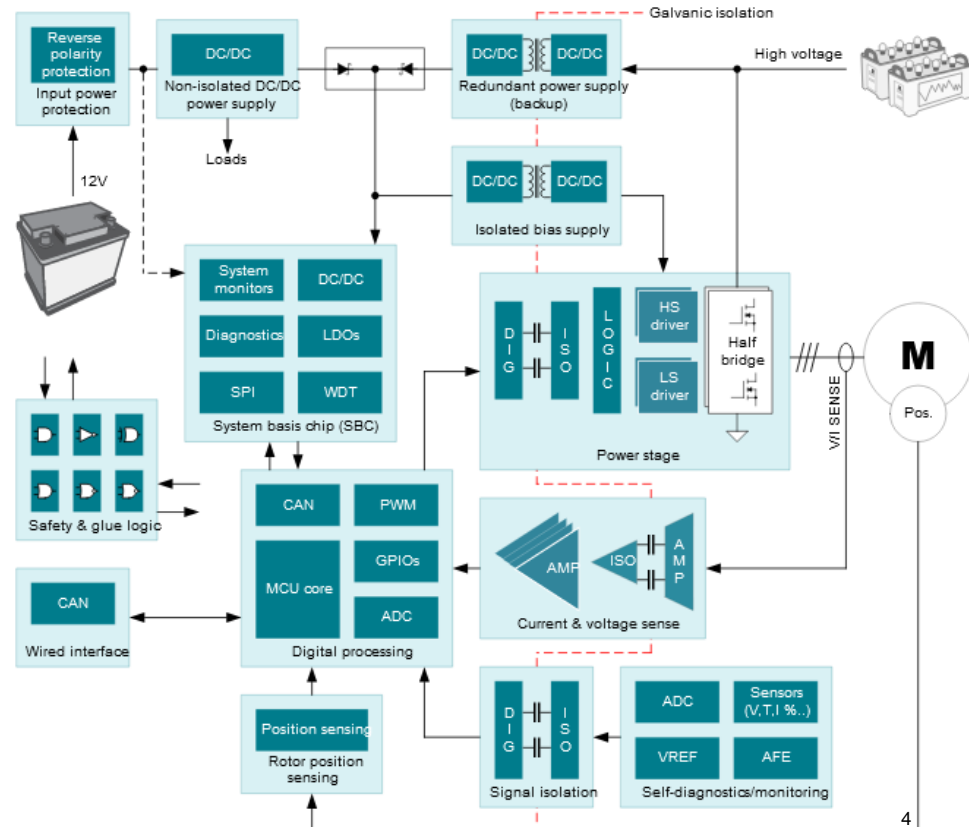
- Converts DC to AC
- Controls speed and torque
- Directly impacts efficiency & reliability

Inverter & motor control: market trends



Technology trends

- **Increased power levels**
 - 100 kW to 500 kW
- **Higher battery voltage**
 - From 400 V to 800 V
- **Higher power density**
 - Up to 50 kW/L
 - System integration
- **Maintaining safety and reliability**



Key traction inverter design considerations

EV goals

- Maximize EV range
- Improve EV charging
- Make EVs more affordable
- Enable safe operation

Design considerations

- Efficiency
- Cost
- Size
- Protection
- Reliability

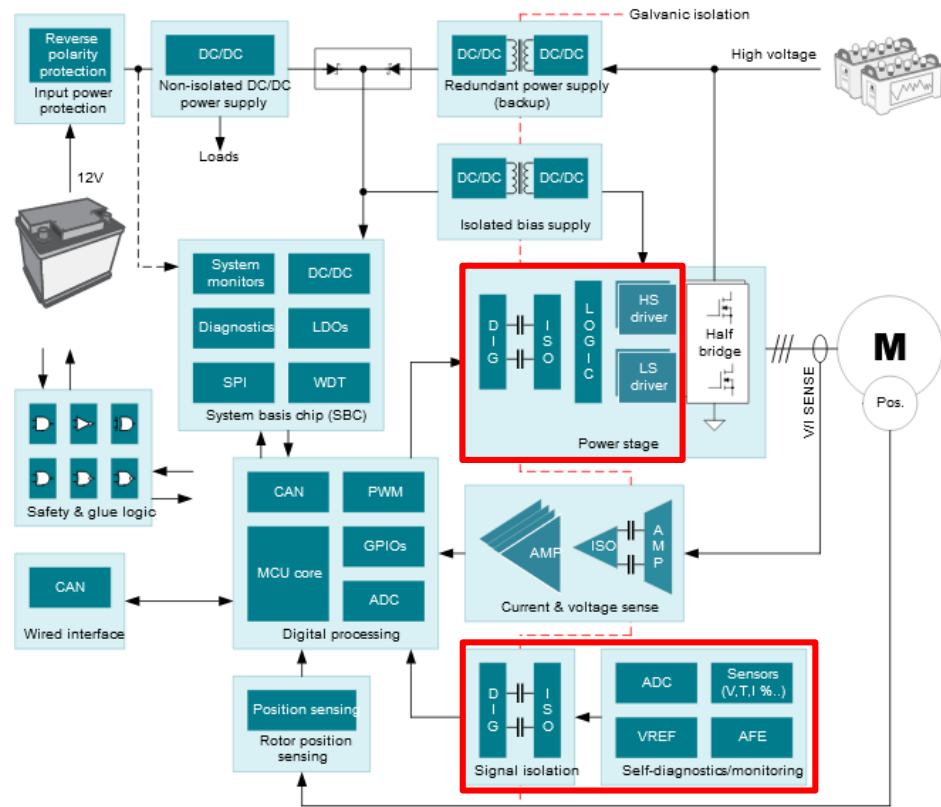
Inverter subsystems

- Controller/MCU
- Bias supply
- Feedback loop
- Bus bars
- Gate drive
- Power modules (SiC/IGBT)

Increasing integration increases the gate driver impact on the system

Modern gate drivers integrate features such as:

- Isolated ADC sensing
 - Power module temperature sensing
 - DC bus voltage monitoring
- DESAT/Over Current protection
- Bias monitoring (Under voltage and over voltage)
- FET Gate monitoring
- Programmable safe state
- Built-in self test
- **Real-time variable gate drive strength**



Major problem & challenges to solve in HEV/EV

Problem: Loading, temperature and battery voltage affect electric vehicle efficiency, EMI, and SiC VDS overshoot impacting battery size, cost, drive range per charge, and reliability.

Design challenge: Implement real-time variable power stage gate drive based on different operating conditions in order to maximize efficiency, while controlling EMI and VDS overshoot

- High Current leads to inductive spikes during transitions
- Low Temperature leads to reduced SOA on VDS
- High Battery Voltage leads to higher voltage spikes as the max spike voltage is directly proportional to the DCLINK voltage

UCC5880-Q1 enables increased efficiency, overshoot control, increased power density and reduced system cost through **real-time variable gate drive strength** and protection and monitoring feature integration

Loading

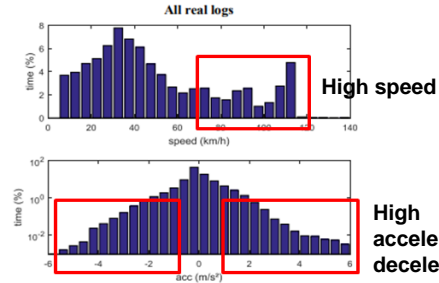
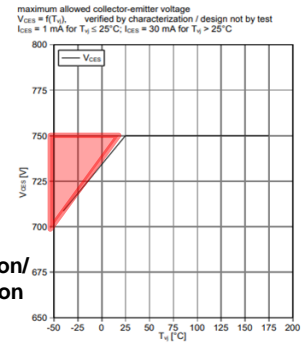
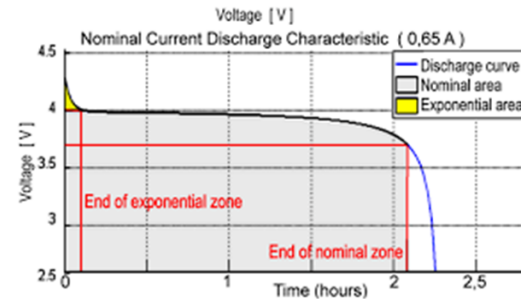


Figure 9. WLTP and real logs speed and acceleration histograms

Temperature

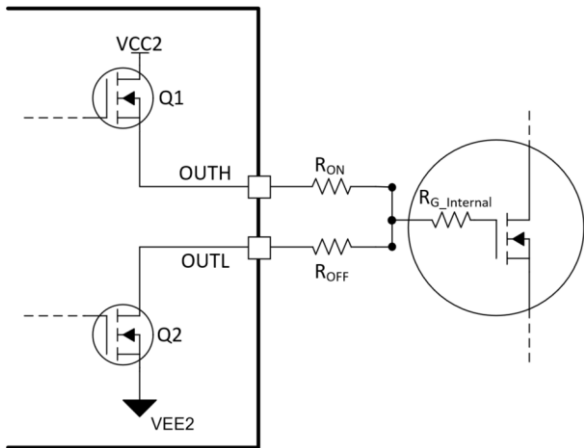


High Voltage



What is variable gate drive strength?

Traditional gate driver output structure

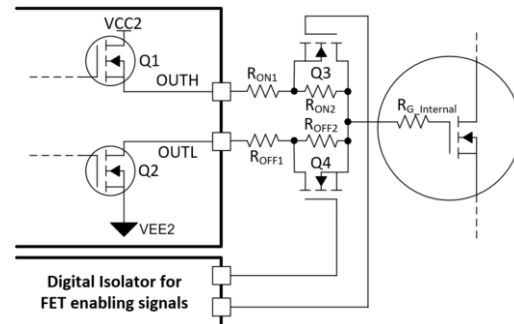


- Single driver power stage, Q1 and Q2
- Drive strength determined by impedance of Q1, Q2, and $R_{G_Internal}$
- Further determined by R_{ON} and R_{OFF}
- Not real-time variable

Variable gate drive implementation

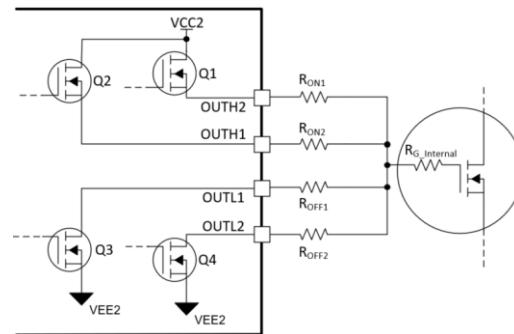
Discrete

- Single power stage
- Adds external components (FETs, digital Isolator, RCs)
- Drive strength adjusted by enabling/disabling Q3 & Q4



Integrated

- **Dual split output power stage**
- Control signals via GPIO or SPI
- **Reduced cost & complexity when compared to discrete**
- Easier control of drive strength over operating conditions



Power switch transient elements

Gate drive strength affects **switching speed (switching losses, VDS/VCE overvoltage)**

- RG sized to prevent VDS overvoltage violation under worst case conditions
 - Not optimal for nominal operating conditions

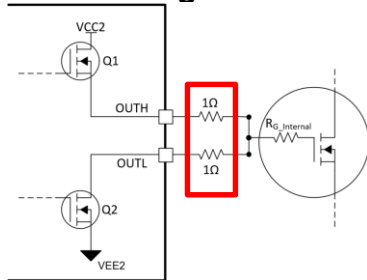
Test conditions

Module	CAB450M12XM3
VBUS	800 V
I _{LOAD}	450 A
T _J	25 C (Ambient)

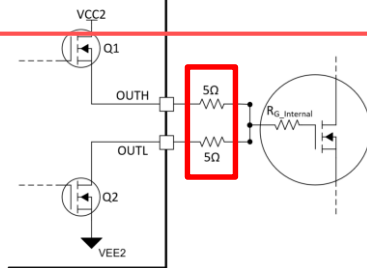
Test results

Drive strength	Weak drive (5Ω)	Strong drive (1Ω)
E _{ON} (mJ)	40 mJ	16.5 mJ
E _{OFF} (mJ)	39.7 mJ	20.2 mJ
VDS _{PEAK} (V)	1018 V	1157 V

Drive strength

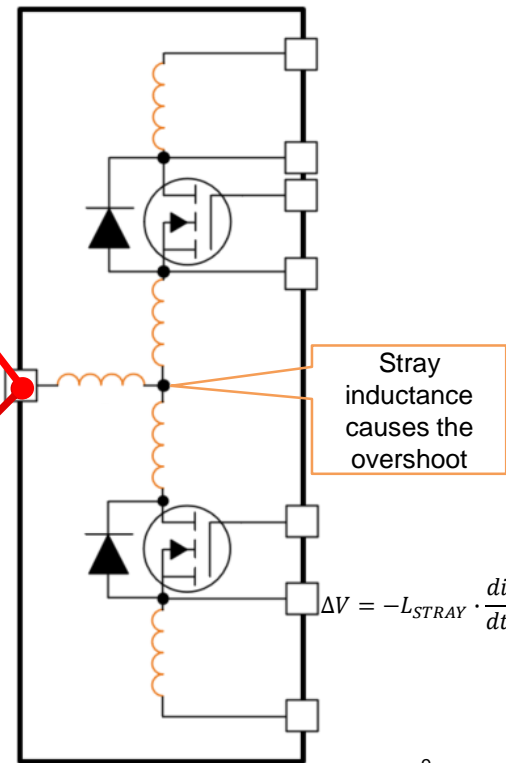
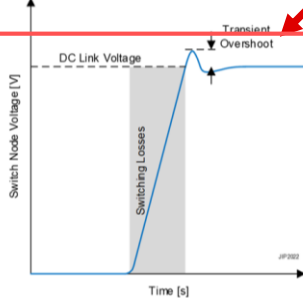
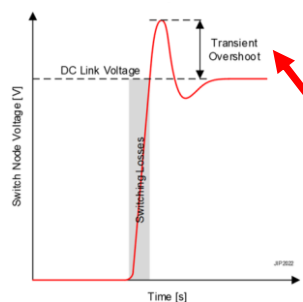


Strong Drive



Weak Drive

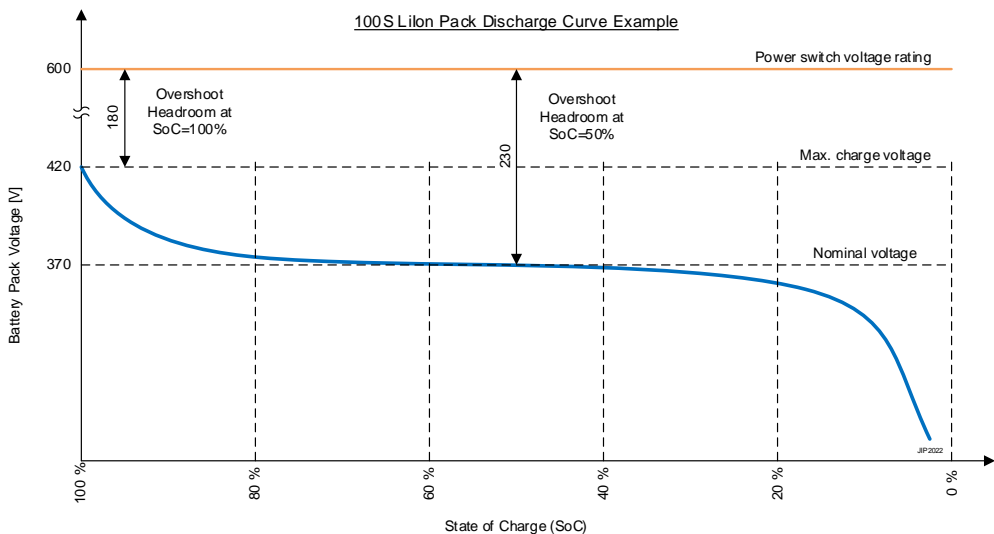
Switch node



Transient overshoot management and efficiency Optimization

Real-time variable gate drive strength (VGDS) enables optimization of transient overshoot and efficiency

- Fully charged battery pack (SoC from 100% to ~80%) requires **weak gate drive** strength to maintain the overshoot within the headroom
- Slightly discharged battery (SoC from 80% to 20%) allows for **strong gate drive**
- Variable gate drive strength increases system efficiency for approx. $\frac{3}{4}$ of the charging cycle



UCC5880-Q1 isolated gate driver + UCC14240-Q1 isolated bias for traction inverters

Industry-leading high integration & advanced isolated SiC/IGBT driver + industry's smallest, lightest isolated bias

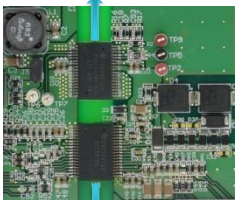
UCC5880-Q1: Isolated driver

- ✓ ± 20A split output drive, dual output
- ✓ Real-time variable drive current
- ✓ 75 ns programmable short-circuit protection
- ✓ >100 V/ns CMTI
- ✓ ISO26262-compliant (ASIL-D)
- ✓ SPI-programmable
- ✓ Reinforced Isolation

UCC14240-Q1: Isolated bias

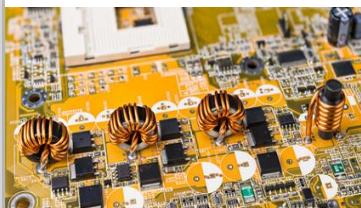
- ✓ 1.5 W - 2 W isolated Bias
- ✓ 3.55 mm height SOIC package
- ✓ ± 1% output accuracy (SiC)
- ✓ Reinforced isolation
- ✓ Over-power/temperature protection
- ✓ Fault communication
- ✓ ISO26262-capable (FS support)
- ✓ >150 V/ns CMTI
- ✓ Vibration & noise immunity

UCC14240-Q1
3.55 mm height
96 mm² area

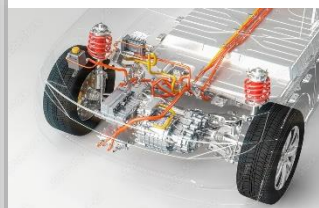


UCC5880-Q1
2.65mm height
77mm² area

Inverter board implications



Inverter system implications



EV / HEV benefits



>2X smaller PCB area, 4mm height
Eliminates 30+ discrete components

±20A split output (no booster stage) +
dual output + real-time variable

No bulky external transformers

75ns short-circuit protection,
±1% output voltage regulation

V_{gth} power switch monitoring

2-channel ADC + SPI + diagnostics

Highest density, lower cost

Optimized efficiency & overshoot

Lower weight, vibration immune

SiC protection

Failure prediction

ISO26262 certification

Smaller

Lighter

Lower cost

Integrated powertrain

More reliable

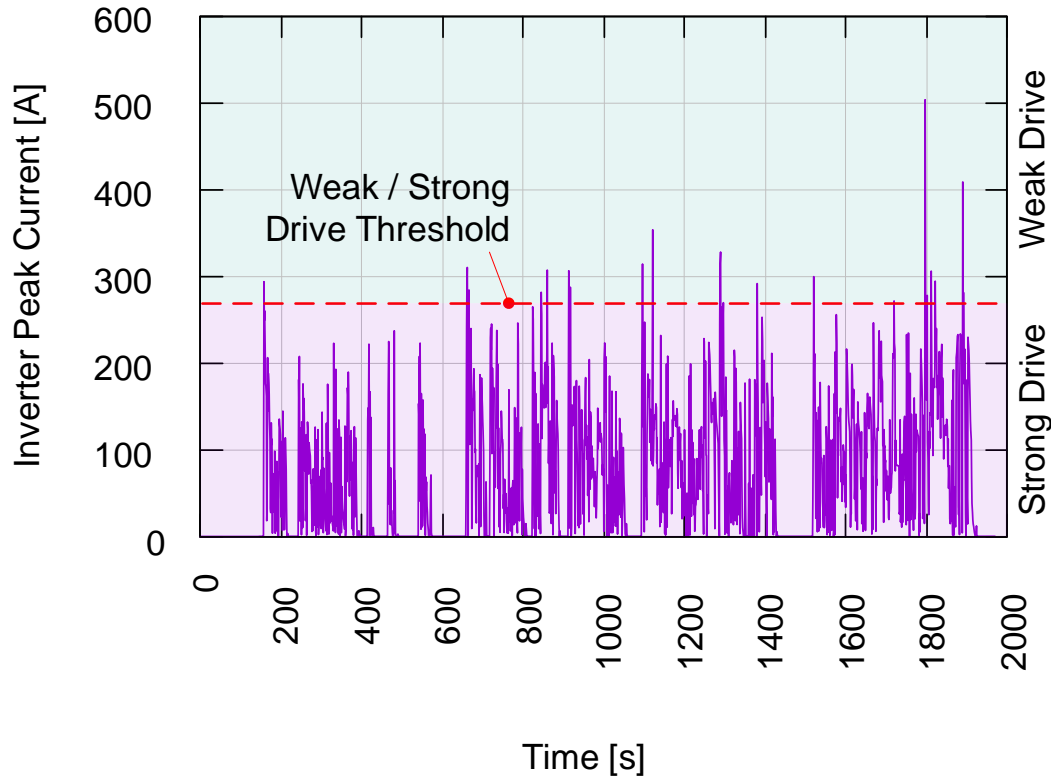
Safety standards

+20 km Longer Range
per charge

~\$300 battery cost
saving

Passenger safety

Designing for real conditions



Hardware has to support the highest current peak

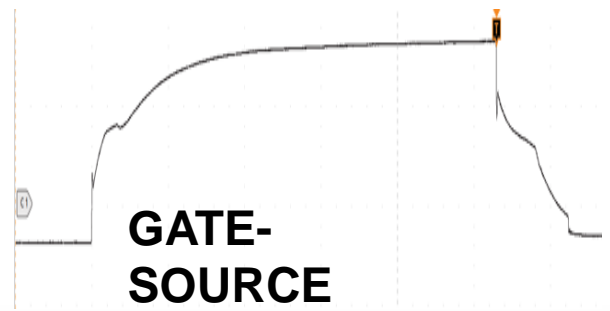
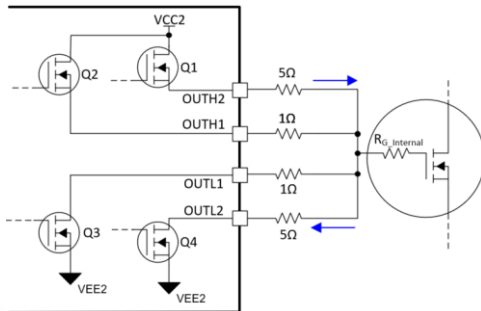


The inverter stays in the strong drive region most of the driving cycle

Gate drive strength selection | Weak vs strong

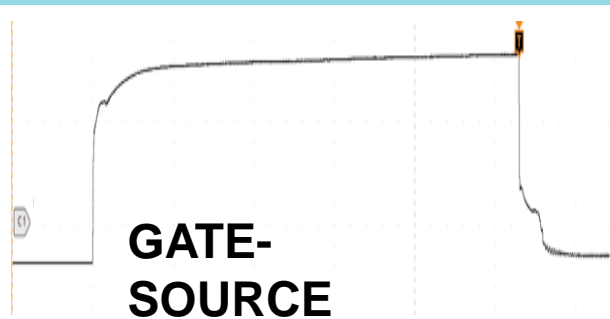
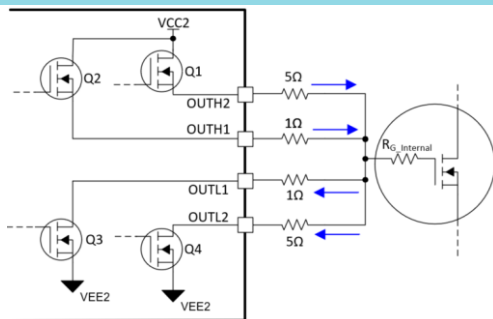
Weak gate drive strength criteria

- High load current (di/dt)
- >80% peak battery voltage at max charge
- Cold temperature



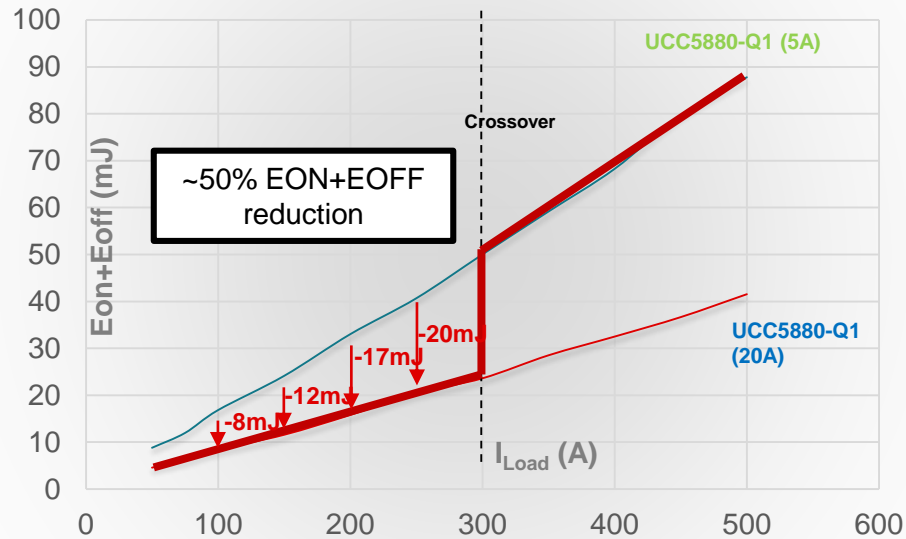
Strong gate drive strength criteria

- Low load current
- <80% peak battery voltage at max charge
- Ambient & Hot temperature

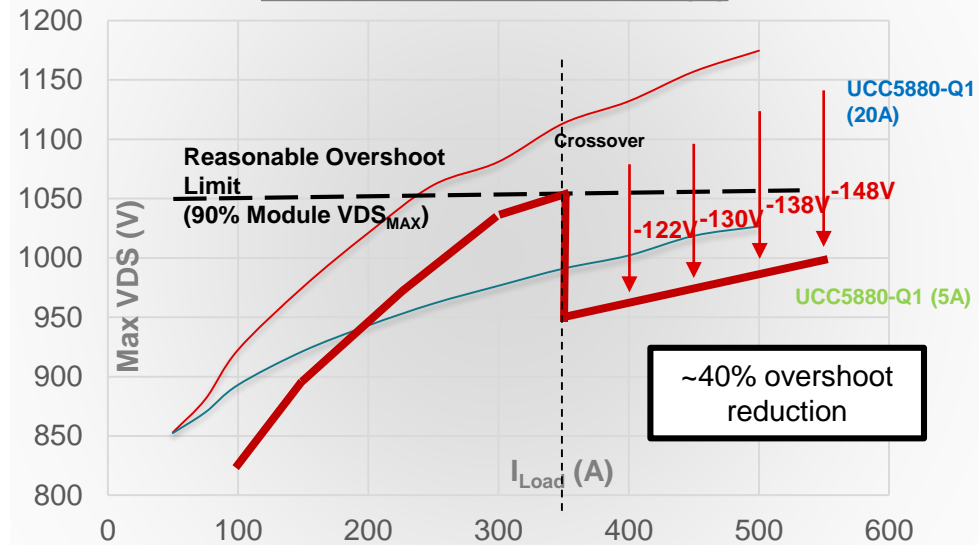


Variable drive strength performance

UCC5880-Q1: Eon+Eoff (mJ)



UCC5880-Q1: Overshoot (V)

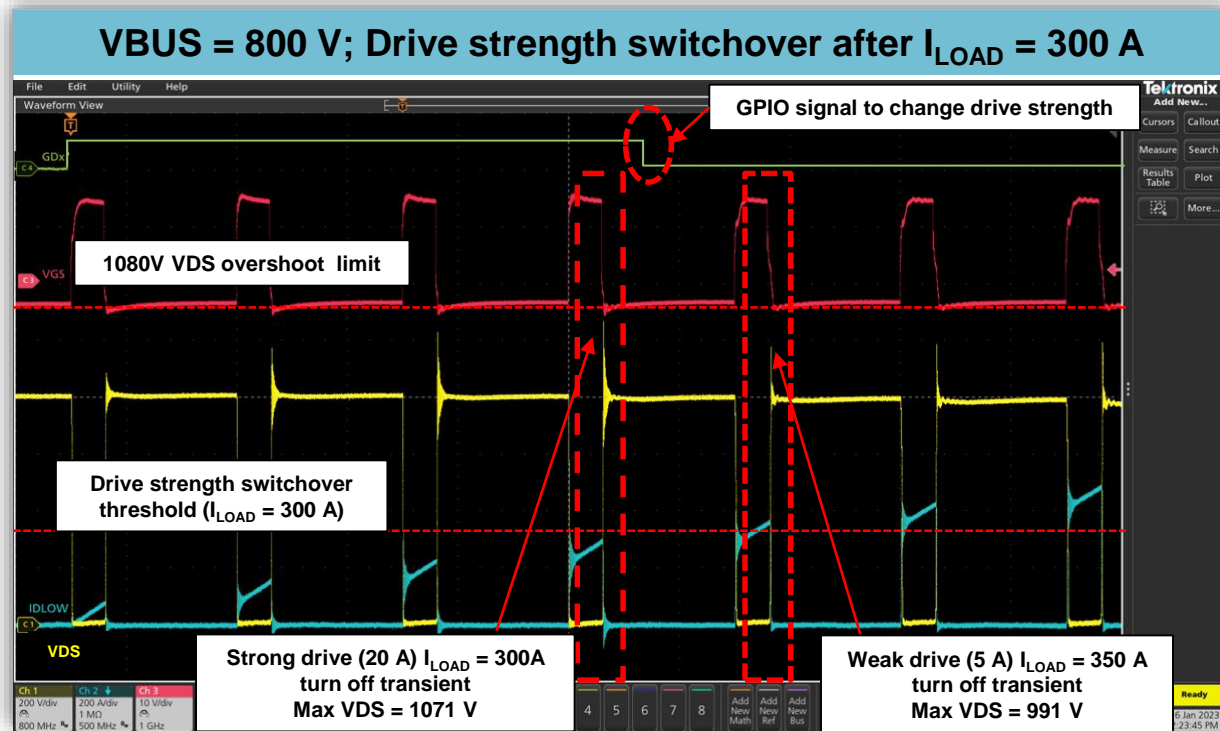


Conclusion

- Traditional output structure must be optimized for worst case overshoot which impacts nominal switching losses.
- Real-time variable drive strength implementation allows optimization of switching losses across full load current range.

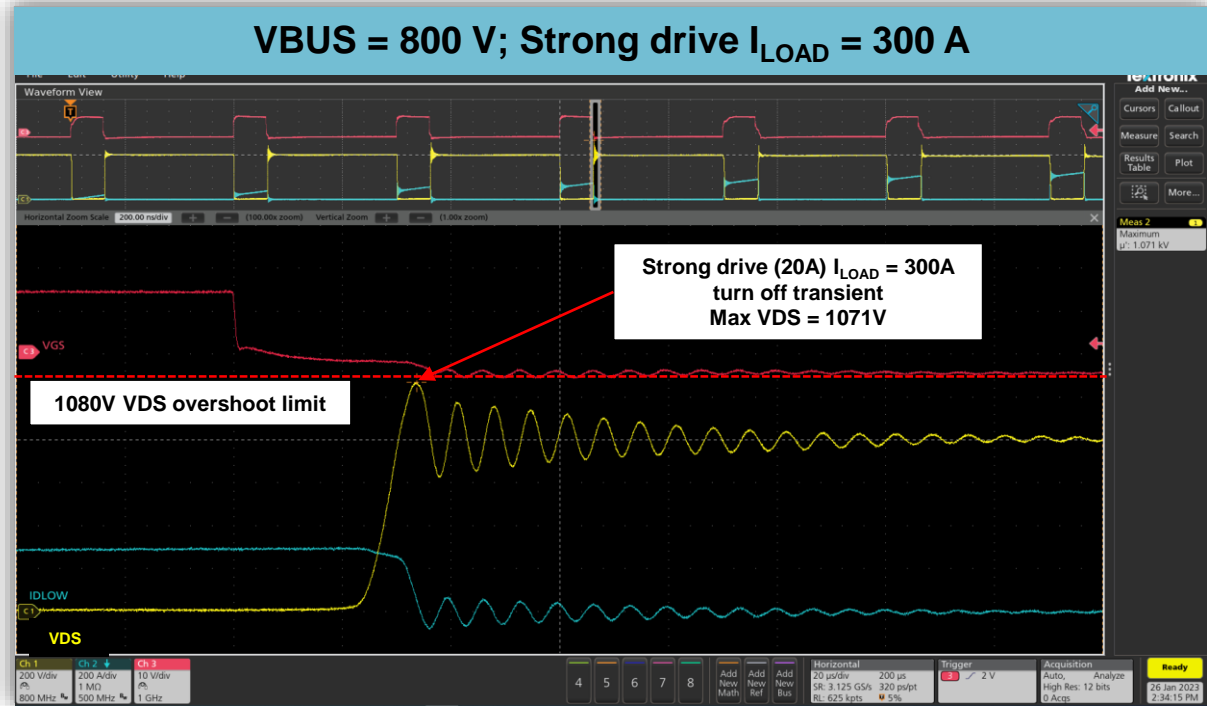
Variable drive strength change reduces VDS overshoot

- Drive strength determined by operating conditions
- Need MCU or hardware logic intervention (SPI or GPIO)
- Changes drive strength **in real time** from one cycle to the next
 - Not intended to shape switching waveform



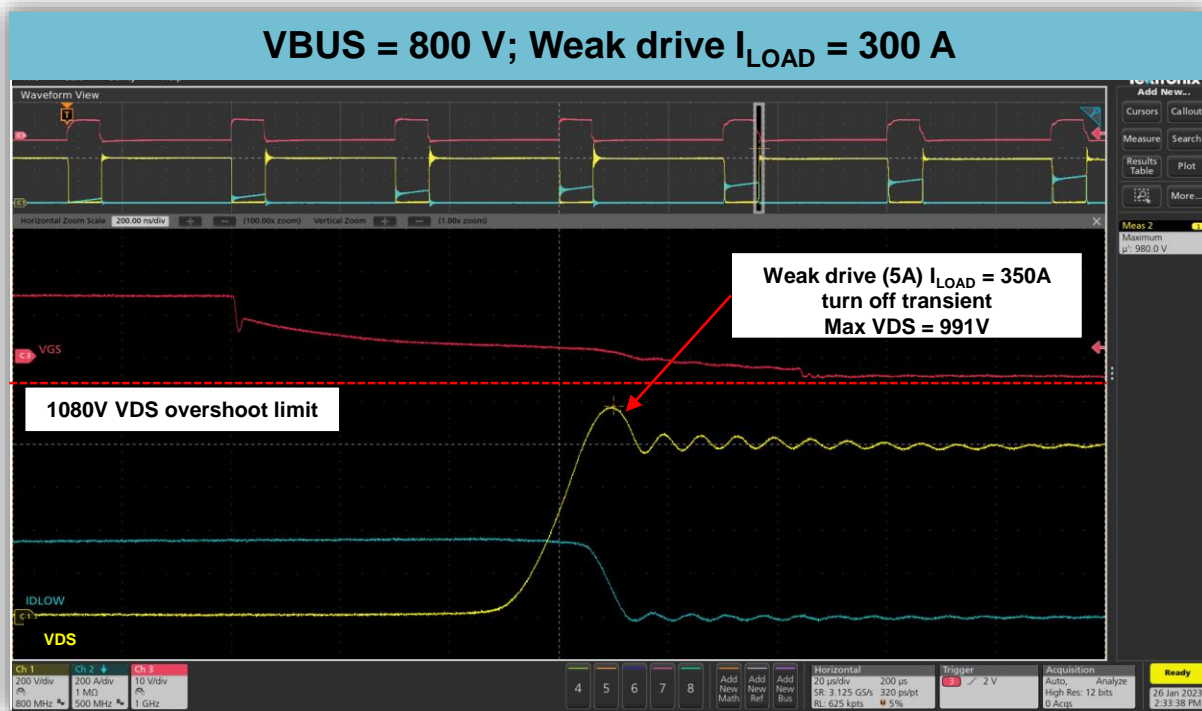
Variable drive strength: Strong drive at 300 A

- Drive strength determined by operating conditions.
- Need MCU or hardware logic intervention (SPI or GPIO).
- Changes drive strength **in real time** from one cycle to the next:
 - Not intended to shape switching waveform



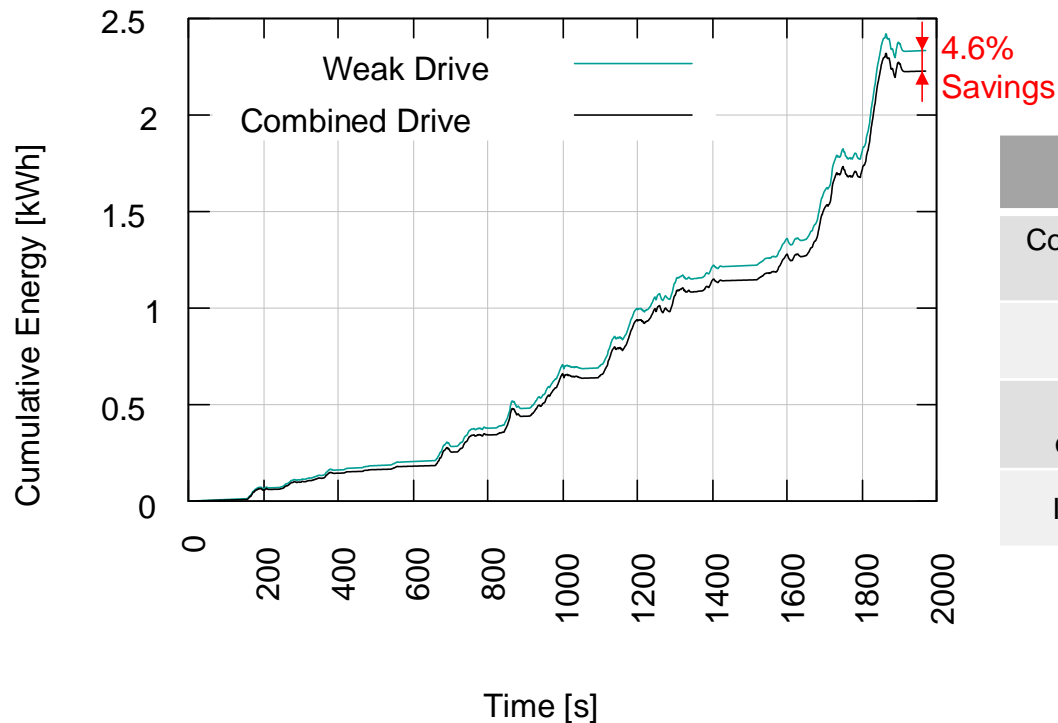
Variable drive strength: Weak Drive at 300A

- Drive strength determined by operating conditions.
- Need MCU or hardware logic intervention (SPI or GPIO).
- Changes drive strength **in real time** from one cycle to the next:
 - Not intended to shape switching waveform



Vehicle Efficiency Improvements

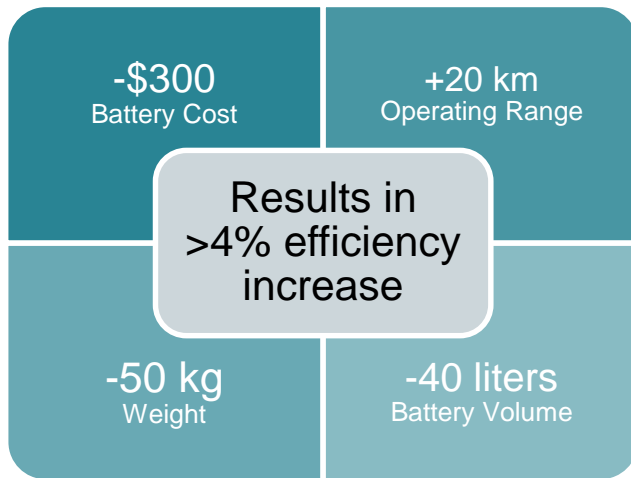
CLTC Driving Cycle with and without the Real-Time Gate Driver Strength Feature (Test Data for a Compact Vehicle)



Parameter	Weak drive	Combined drive	Unit
Consumption per CLTP cycle	2.330	2.224	kWh
Distance	14.94	14.94	km
Average consumption	156	148	W/km
Improvement	-	> 4	%

Vehicle benefits from real-time variable gate drive

- The real-time variable gate driver strength feature significantly improves the light load efficiency
- Typical passenger vehicle operates in light-load conditions most of time



(Assumed 76 kWh usable battery, 470 km range, 162 Wh/km efficiency)

Getting started

You can start evaluating this device leveraging the following:

Resource type	Title	Link to content or more details
Product folder	UCC5880-Q1	https://www.ti.com/product/UCC5880-Q1
Reference design	800V/300kW traction inverter reference design	https://www.ti.com/tool/TIDM-02014
Customer training series or webinar session	Protecting power devices in EV applications	https://www.ti.com/video/6245177995001?context=1134585-1148168-1148181
Technical blog content or white paper	How to maximize SiC traction inverter efficiency with real-time variable gate drive strength	https://e2e.ti.com/blogs_/b/behind_the_wheel/posts/how-to-maximize-sic-traction-inverter-efficiency-with-real-time-variable-gate-drive-strength
Selection and design tools and models	FuSa documents, full datasheet, Simmetrix model, power dissipation calculator	https://www.ti.com/product/UCC5880-Q1
Development tool or evaluation kit	UCC5880-Q1 half-bridge evaluation module for 20-A, isolated, adjustable IGBT/SiC MOSFET gate driver	https://www.ti.com/tool/UCC5880QEVMM-057

Visit www.ti.com/npu

For more information on the New Product Update series, calendar and archived recordings



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